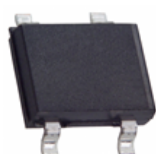


1.0A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER
Features

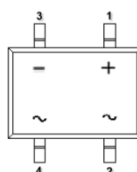
- Glass Passivated Die Construction
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Surface Mount Application
- UL Listed Under Recognized Component Index, File Number E94661
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

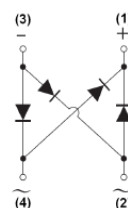
- Case: DF-S
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Tin. Solderable per MIL-STD-202, Method 208 
- Polarity: As Marked on Case
- Weight: 0.38 grams (Approximate)



Top View



Pin Diagram



Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DFxS	DF-S	50/Tube
DFxS-T	DF-S	1500/Tape & Reel, 13-inch

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information


011 = Manufacturers' Code Marking
 DFxxxS = Product Type Marking Code, ex: DF10S
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 6 for 2016)
 WW = Week Code (01 to 52)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	DF 005S	DF 01S	DF 02S	DF 04S	DF 06S	DF 08S	DF 10S	Unit
Peak Repetitive Reverse Voltage	V _{RMM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V _{RWM}								
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average Forward Rectified Current @ T _A = +40°C	I _O	1.0							A
Non-Repetitive Peak Forward Surge Current, 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50							A

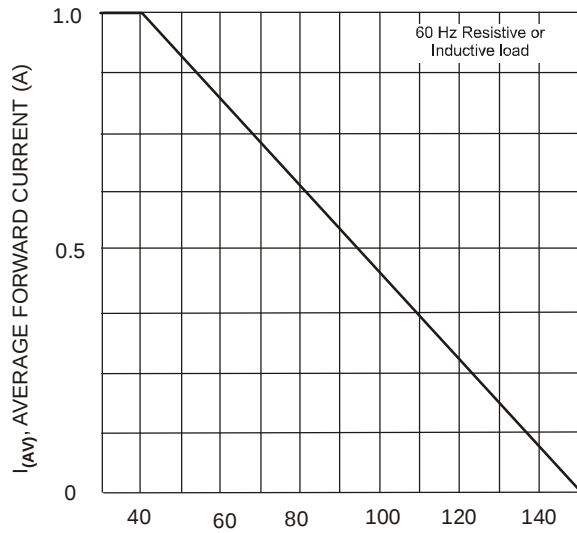
Thermal Characteristics

Characteristic	Symbol	DF 005S	DF 01S	DF 02S	DF 04S	DF 06S	DF 08S	DF 10S	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	40							°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150							°C

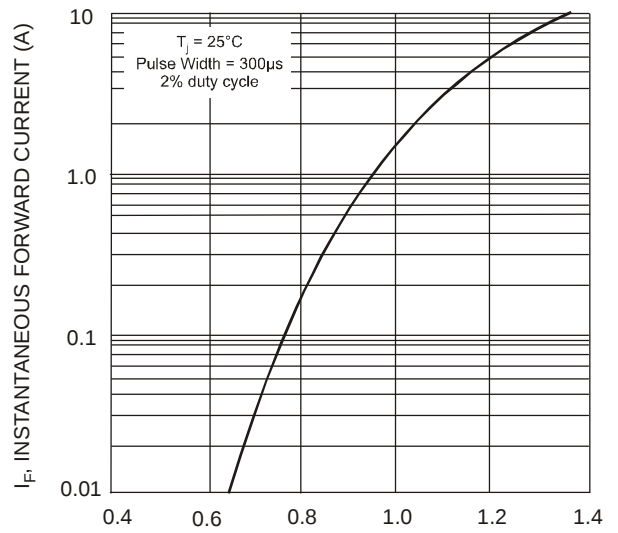
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	DF 005S	DF 01S	DF 02S	DF 04S	DF 06S	DF 08S	DF 10S	Unit
Forward Voltage (Per Element) @ I _F = 1.0A	V _{FM}	1.1							V
Peak Reverse Current at Rated @ T _A = +25°C	I _{RM}	10							μA
DC Blocking Voltage (Per Element) @ T _A = +125°C		500							
I ² t Rating for Fusing (t<8.3ms)	I ² t	10.4							A ² s
Typical Total Capacitance (Per Element) (Note 5)	C _T	25							pF

Notes: 5. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
6. Thermal resistance, junction to ambient, measured on PC board with 5.0mm² (0.03mm thick) land areas.



T_A , AMBIENT TEMPERATURE ($^{\circ}\text{C}$)
Fig. 1 Output Current Derating Curve



V_F , INSTANTANEOUS FORWARD VOLTAGE (V)
Fig. 2 Typical Forward Characteristics (per element)

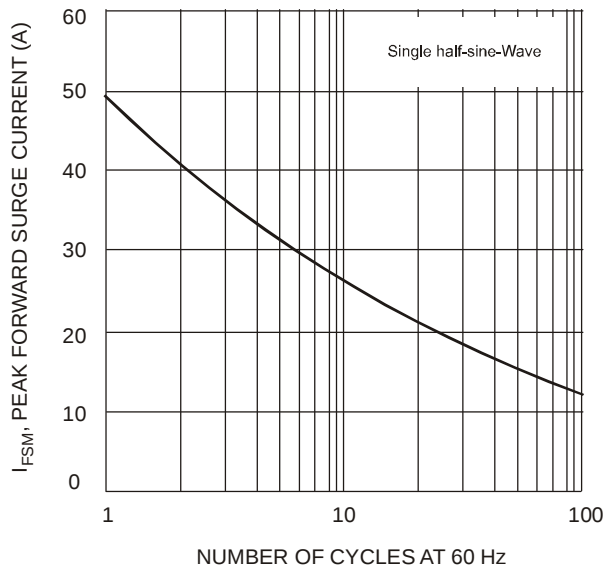


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

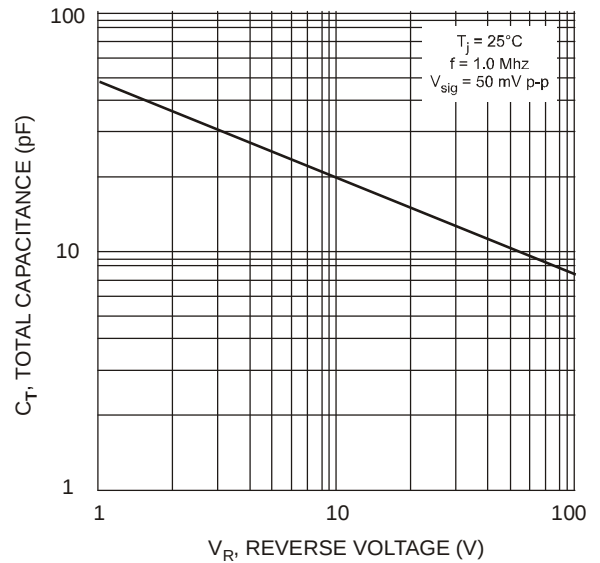
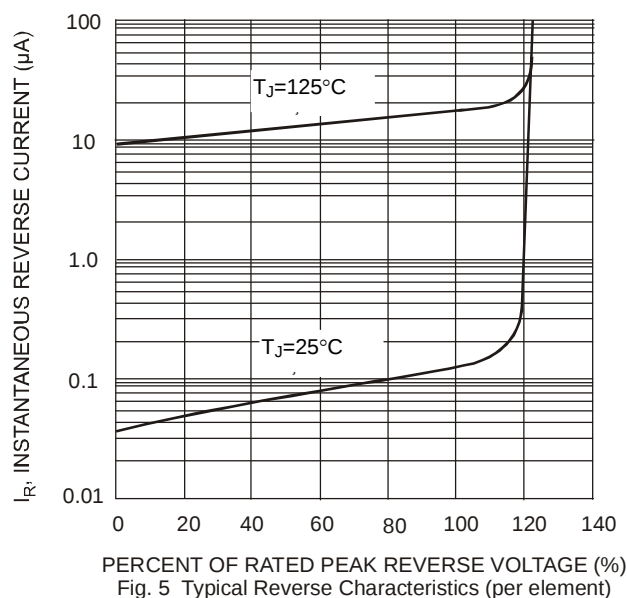
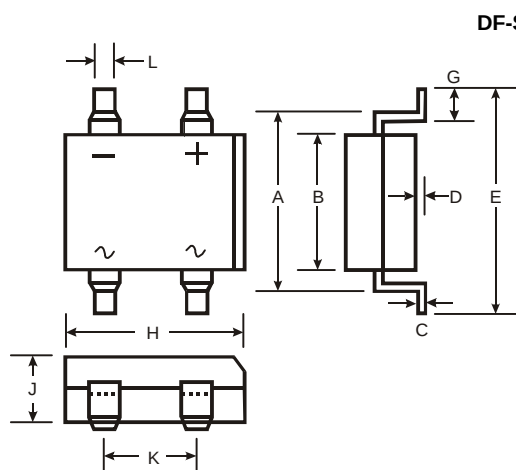


Fig. 4 Typical Total Capacitance (per element)



Package Outline Dimensions

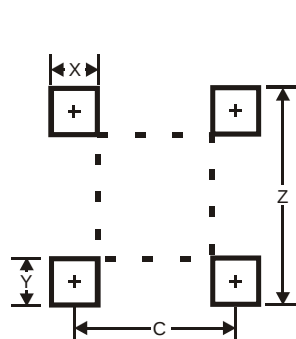
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



DF-S		
Dim	Min	Max
A	7.40	7.90
B	6.20	6.50
C	0.22	0.30
D	0.076	0.33
E	—	10.40
G	1.02	1.53
H	8.13	8.51
J	2.40	2.60
K	5.00	5.20
L	1.00	1.20
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
Z	10.26
X	1.2
Y	1.52
C	5.2

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2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

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